









PRODUCT DATASHEET



- ► PCB / CHIP LED
- ▶ 0603 (1608) 0.55t
- ► Red/Yellow (620/590nm)

N0D48S00



0603 0.55t Series





Release Date: 13 January 2023 Version: A1.1

0603 0.55t Series

APPLICATIONS:

- Backlighting
- Indication Light
- Switch light
- Dashboard

FEATURES:

- Package: PCB / CHIP LED Dual Colour Top View Package
- Forward Current: 20/20mA*
- Forward Voltage (typ.): 2.0/2.0V
- Luminous Intensity (typ.): 140/170@20mA
- Colour: Red/Yellow
- Dominant Wavelength (typ.): 620/590nm
- Viewing angle: 140°
- **Materials:**
 - Die: AlGaInP-GaAs/AlGaInP-GaAs
 - Resin: Epoxy (Water Clear)
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+85°C
- **Grouping parameters:**
 - Forward voltage
 - Luminous intensity
 - **Dominant Wavelength**
- Soldering methods: Reflow
- MSL Level: acc. to JEDEC Level 3
- Packing: 8mm tape with max.4000/reel, ø180mm (7")

^{*} In the order of Red/Yellow.



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	30/30*	mA
Peak Forward Current Duty 1/8@1KHz	I _{FP}	125	mA
Reverse Voltage	V _R	5	V
Reverse Current @5V	I _R	10	μΑ
Power Dissipation	P _D	75/75	mW
Operating Temperature	T _{OPR}	-40~+80	°C
Storage Temperature	T _{STG}	-40~+85	°C

^{*} In the order of Red/Yellow.

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Cumbal	Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition
Forward Voltage	VF	1.7/1.7*	2.0/2.0	2.5/2.5	V	I _F =20mA
Luminous Intensity	lv	80/80	140/170	250/250	mcd	I _F =20mA
Dominant Wavelength	λ_{D}	615/585	620/590	630/595	nm	I _F =20mA
Peak Wavelength	λ_{P}		630/595		nm	I _F =20mA
Spectral Line Half Bandwidth	Δλ		19/17		nm	I _F =20mA
Viewing Angle	2θ _{1/2}		140		deg	I _F =20mA

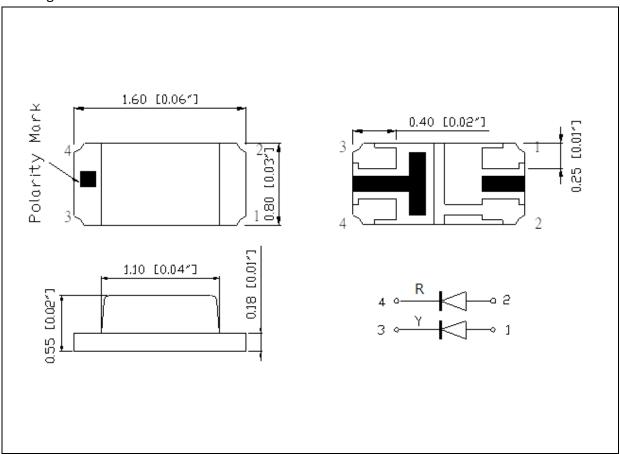
^{1.} Luminous intensity (Iv) $\pm 15\%$, Forward Voltage (V_F) ± 0.1 V, Viewing angle($2\theta_{1/2}$) $\pm 5\%$

^{2. *} In the order of Red/Yellow.



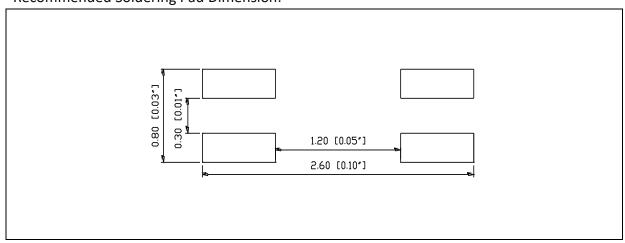
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

Со	ode	Min.	Max.	Unit
Red		1.7	2.5	V
Yellow		1.7	2.5	V

Luminous Intensity Classifications (I_F = 20mA):

Co	ode	Min.	Max.	Unit
	I	80	100	
	J	100	125	
Red	K	125	160	mcd
	L	160	200	
	М	200	250	
	I	80	100	
	J	100	125	
Yellow	K	125	160	mcd
	L	160	200	
	М	200	250	

Dominant Wavelength Classifications (IF = 20mA):

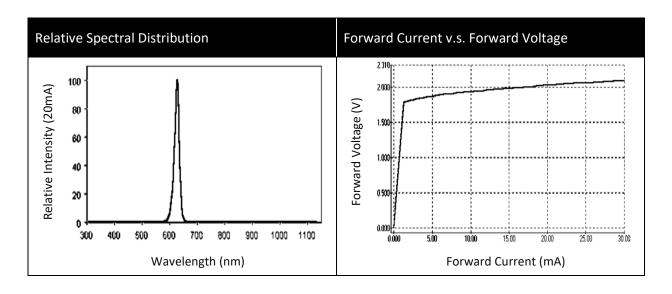
Code		Min.	Max.	Unit
	S	615	620	
Red	t	620	625	nm
	u	625	630	
Yellow	m	585	590	2.22
	n	590	595	nm

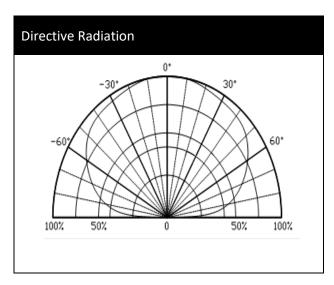
Example Group Name on Label:

•	
	(160~200mcd) ► m (585~590nm) ► 20 (IF=20mA)



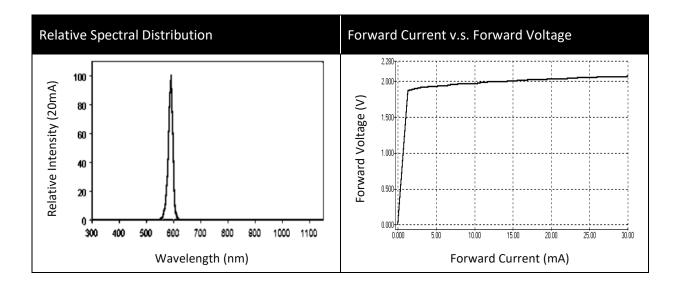
ELECTRO-OPTICAL CHARACTERISTICS (RED):

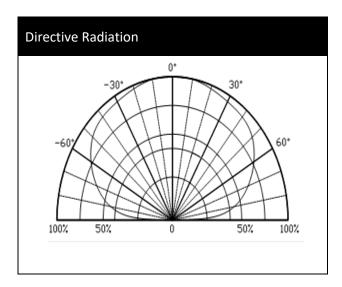






ELECTRO-OPTICAL CHARACTERISTICS (YELLOW):

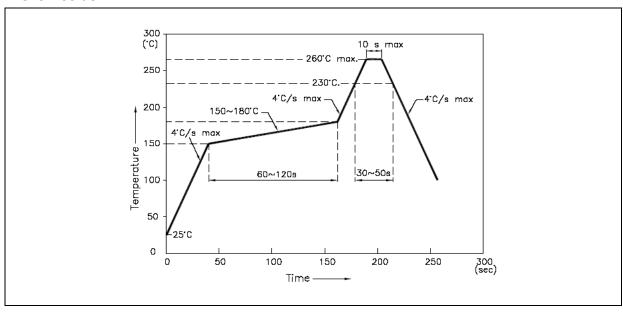






RECOMMENDED SOLDERING PROFILE:

Reflow Solder:



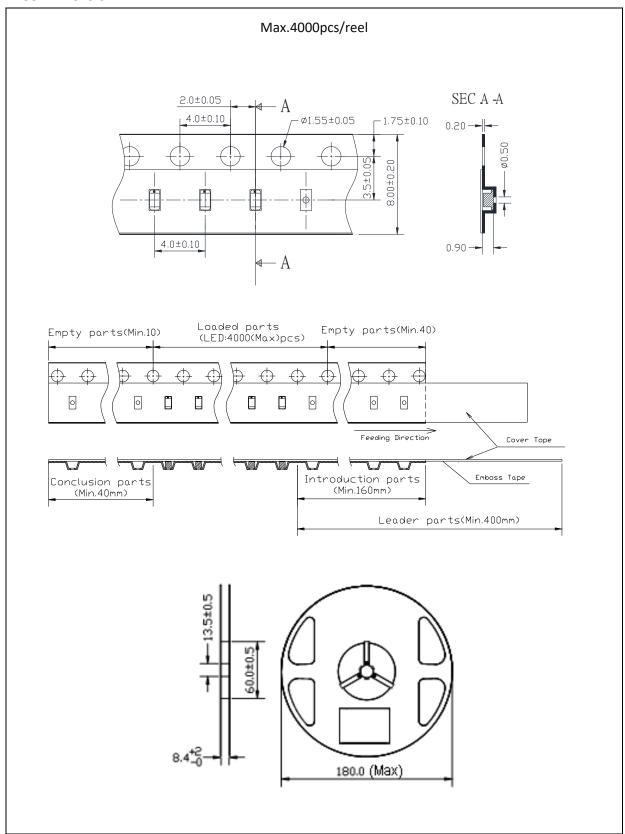
Note:

- 1. Recommend reflow temperature 245°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maximum reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

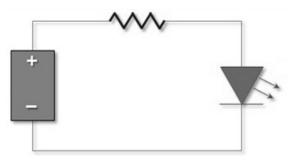
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	23/10/2014	Datasheet set-up.
A1.1	13/01/2023	New datasheet format.